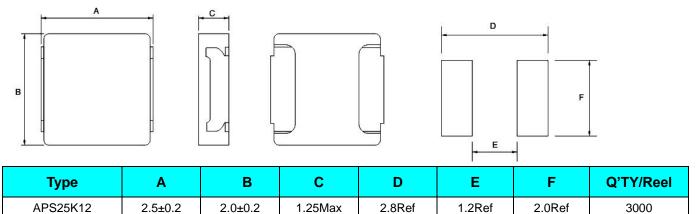


## 1. External Dimensions (Unit:m/m)



### 2. Part Number Code

<u>AP</u>	<u>'S</u>	<u>25</u>	<u>K</u>	<u>12</u>	M	<u>2R2</u>				
A		В	С	D	Е	F				
A:	Seri	es Nan	ne		S	upper Power Inductors				
B:	B: Dimensions(mm)					25: 2.5x2.0				
C:	: Materials				NO use					
D: Thickness(mm)					12: 1.25 Max					
E:	Tole	rance			Ν	∕I: ±20%				
F:	Indu	ctance			2	R2=2.2uH				

### 3. Electrical Characteristics

Part Number	Inductance (µH)	Inductance Test Frequency (µH) (MHz)		Heat Rating Current DC(A) Max.	Saturation Current DC(A) Max.	
APS25K12M2R2	2.2	1MHz	100.0	2.2	2.2	

Notes:

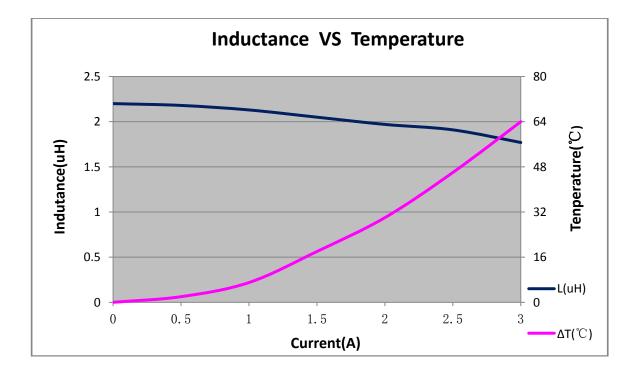
- a. All test data is referenced to  $25^{\circ}$ C ambient.
- b. Operating Temperature Range-40℃ to +125℃.
- c. DC current(A) that will cause an approximate  $\triangle$  T of 40 °C.
- d. DC current(A) that will cause Lo to drop approximately 40%.
- e. The part temperature(ambient + temp rise)should not exceed 125°C under worst case operating conditions. Circuit design,component placement, PWB trace size and thickness,airflow and other cooling provisions all affect the part temperature, Part temperature should be verified in the end application.



# 4. Test Data

E	LECTRICA	L CHARCTE	RISTIC	MECHANICAL DIMENSIONS						
SPEC	L(uH)	DCR(mΩ)	Isat(uH)	A(mm)	B(mm)	C(mm)	D(mm)			
TOL	2.2	100.0	2.2A	2.5	2.0	1.25	2.8			
NO	±20%	Max	(L0A-L2.2A) /L0A≤40%	±0.2	±0.2	Max	Ref			
1	2.16	86.3	1.56	2.61	2.10	1.15	ОК			
2	2.06	86.4	1.61	2.59	2.12	1.13	ОК			
3	2.19	85.9	1.56	2.62	2.10	1.15	ОК			
4	2.15	82.9	1.53	2.56	2.12	1.14	ОК			
5	2.18	89.6	1.58	2.57	2.10	1.15	ОК			
6	2.06	89.4	1.62	2.62	2.11	1.16	ОК			
7	2.13	88.6	1.55	2.63	2.12	1.13	ОК			
8	2.04	85.3	1.59	2.65	2.11	1.15	ОК			
9	2.02	85.6	1.63	2.59	2.09	1.17	ОК			
10	2.06	86.4	1.58	2.60	2.10	1.18	ОК			
Test Equip	Test Equipmets: HP4284A, C16502, E4991									

Curve:





## 5. Test and Measurement Procedures

#### 5.1 Test Conditions

- 5.1.1 Unless otherwise specified, the standard atmospheric conditions for measurement/test as:
  - a. Ambient Temperature: 20±15°C
  - b. Relative Humidity: 65%±20%
  - c. Air Pressure: 86KPa to 106KPa
- 5.1.2 If any doubt on the results, measurements/tests should be made within the following limits:
  - a. Ambient Temperature: 20±2°C
  - b. Relative Humidity: 65%±5%
  - c. Air Pressure: 86KPa to 106Kpa

#### 5.2 Visual Examination

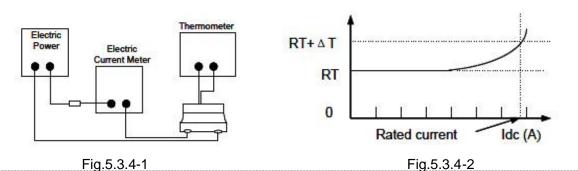
a. Inspection Equipment: 10X magnifier

## 5.3 Electrical Test

- 5.3.1 Inductance (L)
  - a. Refer to Appendix A.
  - b. Test equipment: ZM2355 LCR meter or equivalent.
  - c. Test Frequency and Voltage: refers to Appendix A
- 5.3.2 Direct Current Resistance (DCR)
  - a. Refer to Appendix A
  - b. Test equipment: HIOKI 3540 or equivalent.

#### 5.3.3 Saturation Current (Isat)

- a. Refer to Appendix A
- b. Test equipment: Saturation current meter
- c. Definition of saturation current (Isat): DC current at which the inductance drops approximate 40% from its value without current.
- 5.3.4 Temperature rise current (Irms)
  - a. Refer to Appendix A.
  - b. Test equipment (see Fig.5.3.4-1): Electric Power, Electric current meter, Thermometer.
  - c. Measurement method (see Fig. 5.3.4-1):
    - 1. Set test current to be 0mA.
    - 2. Measure initial temperature of choke surface.
    - 3. Gradually increase current and measure choke temperature for corresponding current.
    - Definition of Temperature rise current: DC current that causes the temperature rise (△ T =40°C) from 20°C ambient (see Fig. 5.3.4-2).



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# 5.4 Reliability Test

Items	Required Characteristics	Test Method/Condition			
		After fluxing, component shall be dipped in a melted. Solder: bath at 235℃±5℃ for 5±0.5 seconds			
Solder Ability Test	The surface of terminal immersed shall be minimum of 90% covered with a new coating of solder	Preheating Dipping Natural cooling			
		150°C = 60 second 5±0.5 second			
		<ul> <li>Preheat:150±5℃ 60seconds.</li> <li>Solder temperature: 250±5℃.</li> </ul>			
		<ul> <li>Flux: rosin.</li> <li>Dip time:10±0.5seconds</li> </ul>			
	1.Components should have not evidence				
Heat endurance of Soldering	of electrical and mechanical damage. 2.Inductance: within±10% of initial value. 3.Impedance: within±10% of initial value.	260°C			
		150°C60 second 10±0.5 second			
Terminal Strength	After soldering of X,Y withstanding at below conditions .The terminal should not Peel off. (Refer to figure at below)				
Vibration Test Inductance change: Within ± 10% Without mechanical damage such as break		<ol> <li>Vibration frequency: (10 Hz to 55 Hz to 10Hz) in 60 seconds as a period</li> <li>Vibration time: Period cycled for 2 hours in each of 3 mutual perpendicular directions.</li> <li>Amplitude: 1.5 mm max.</li> </ol>			
Drop test		Drop specimen three times on concrete floor from a height 0f 1 meter which mounted on test board.			

## **Supper Power Inductors**



Items	Required Characteristics	Test Method/Condition
High Temperature StorageTest	<ol> <li>No case deformation or change in appearance</li> <li>△ L/L ≤ 10%</li> <li>△ Q/Q ≤ 30%</li> <li>△ DCR/DCR ≤ 10%</li> </ol>	Temperature:125°C ±2°C Time:96±2 hours. Tested not less than 1 hour, nor more than 2 hours at room. Temp 125°C High temperature 25°C 0°C High temperature 96H Test Time
Low Temperature Storage Test	<ol> <li>No case deformation or change in appearance.</li> <li>△ L/L≦10%</li> <li>△ Q/Q≦30%</li> <li>△ DCR/DCR≦10%</li> </ol>	Temperature:-40°C ±2°C Time:96±2 hours. Tested not less than 1 hour, nor more than 2 hours at room. 25°C 96H Test 1H 1H Time 0°C High temperature -40°C Temp
Humidity Resistance	<ol> <li>No case deformation or change in appearance.</li> <li>Δ L/L≤10%</li> <li>Δ Q/Q≤30%</li> <li>Δ DCR/DCR≤10%</li> </ol>	1. Environment condition: $60 \pm 2 \degree$ C Humidity: 90–95% Applied Current: Rated current 2. Duration: 1000 + 4 / -0 hours
Thermal Shock Test	<ol> <li>No case deformation or change in appearance.</li> <li>Δ L/L ≤ 10%</li> <li>Δ Q/Q ≤ 30%</li> <li>Δ DCR/DCR ≤ 10%</li> </ol>	1.Repeat 100 cycles as follow: (-40 ± 2 °C; 30 ± 3 min) → (Room temp., 5 min) → (+125 ± 2 °C, 30 ± 3 min) → (Room temp., 5 min) 2. Recovery: 48 + 4 / -0 hours of recovery under the standard condition after the test. Temp 125°C Change time <5 Min 25°C Change time <5 Min 25°C Change time <5 Min 125°C Change time <5 Min

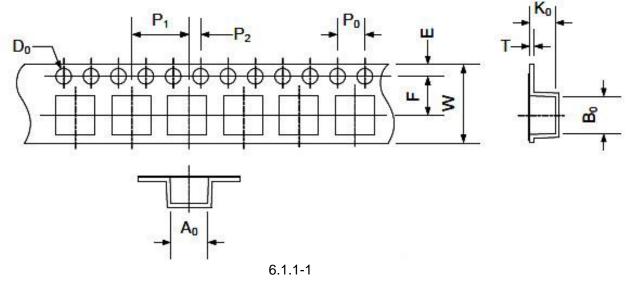
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# 6. Packaging, Storage

## 6.1 Tape and Reel Packaging Dimensions

6.1 .1 Taping Dimensions (Unit: mm)

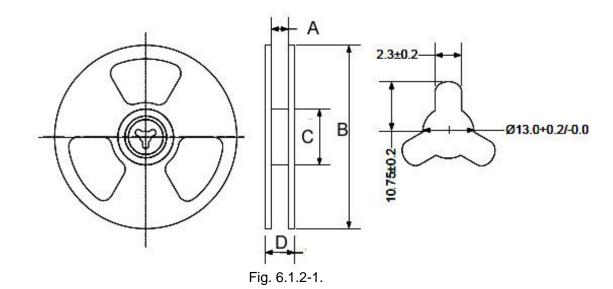
Please refer to Fig. 6.1.1-1



TYPE	А	В	W	Е	F	P0	P1	P2	D0	Т	K0
APS25K12	2.4±0.1	2.8±0.1	8.0±0.3	1.75±0.1	3.5±0.1	4.0±0.1	4.0±0.1	2.0±0.1	1.5±0.1	0.3±0.1	1.35±0.1

6.1.2 Reel Dimensions (Unit: mm)

Please refer to Fig. 6.1.2-1.



ТҮРЕ	А	В	С	D
APS25K12	9.0±2.0	178.0±2.0	58.0±2.0	11.0±2.0



#### 6.2 Packaging

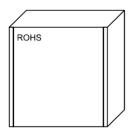
6.2.1 The inner box specification: 195\*192\*65MM

Number: 15000PCS/ box

Sealing bag: 32\*23CM

Job description: putting the air sealing bag products placed

inside the box, sealed with scotch tape



6.2.2 The outside box specification: 410\*405\*165MM

Number: 120000PCS/ box

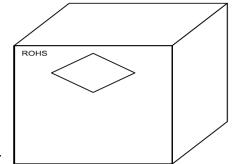
Job description: will be outside the box bottom

sealed, inner box into the box.

- a. With transparent tape sealed box at the top
- b. The specified location with a box labels in the outer box.
- c. If the mantissa box under a FCL with inner box or filling full

# 6.3 Storage

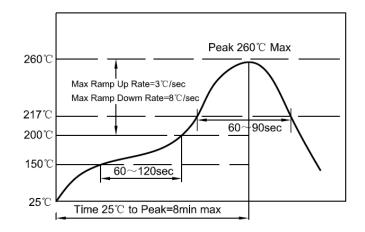
- a.To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.
- b. Recommended conditions: -10  $^\circ C$  -40  $^\circ C$  , 70%RH (Max.)
- c.The ambient temperature must be kept below 30°C.Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used with one year from the time of delivery.
- d. In case of storage over 6 months, solderability shall be checked before actual usage.



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## 7. Recommended Soldering Technologies

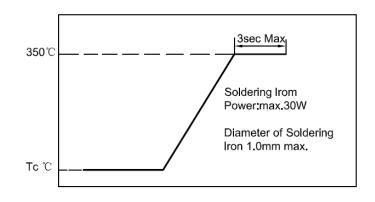
- 7.1 Re-flowing Profile:
  - △ 1~2 °C/sec. Ramp
  - $\triangle$  Pre-heating: 150~190°C/90±30 sec.
  - $\triangle$  Time above 240°C: 20~40sec
  - △ Peak temperature: 255°C Max./5sec;
  - △ Solder paste: Sn/3.0Ag/0.5Cu
  - $\vartriangle$  Max.2 times for Re-flowing



#### 7.2 Iron Soldering Profile:

- △ Iron soldering power: Max.30W
- $\triangle$  Pre-heating: 150°C/60sec.
- △ Soldering Tip temperature:  $350^{\circ}$ CMax.
- △ Soldering time: 3sec Max.
- △ Solder paste: Sn/3.0Ag/0.5Cu
- △ Max.1 times for iron soldering

[Note: Take care not to apply the tip of the soldering iron to the]



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